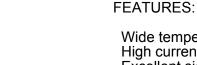
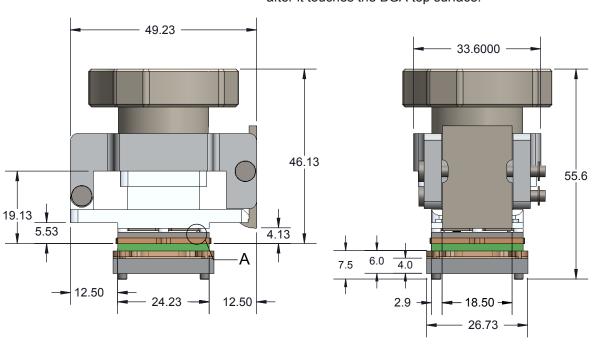
# CBT-BGA DIRECT MOUNT, SOLDERLESS SOCKET FOR BURN-IN AND TEST APPLICATIONS

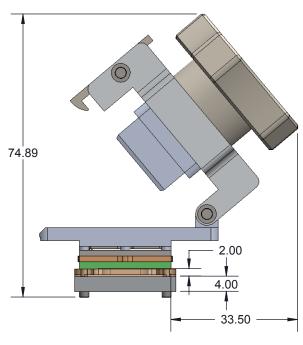


Wide temperature range (-55C to +180C) High current capability (up to 4A) Excellent signal integrity at high frequencies
Low and stable contact resistance for reliable production yield
Highly compliant to accommodate wide co-planarity variations
Automated probe manufacturing enables low cost and short lead time

**DETAIL A** SCALE 10:1

Recommended Torque: 6 in lbs Or Hand tighten Compression screw ~1/3 turn after it touches the BGA top surface.





# Description: CBT-BGA432 19mm 0.8mm 23x23 array

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

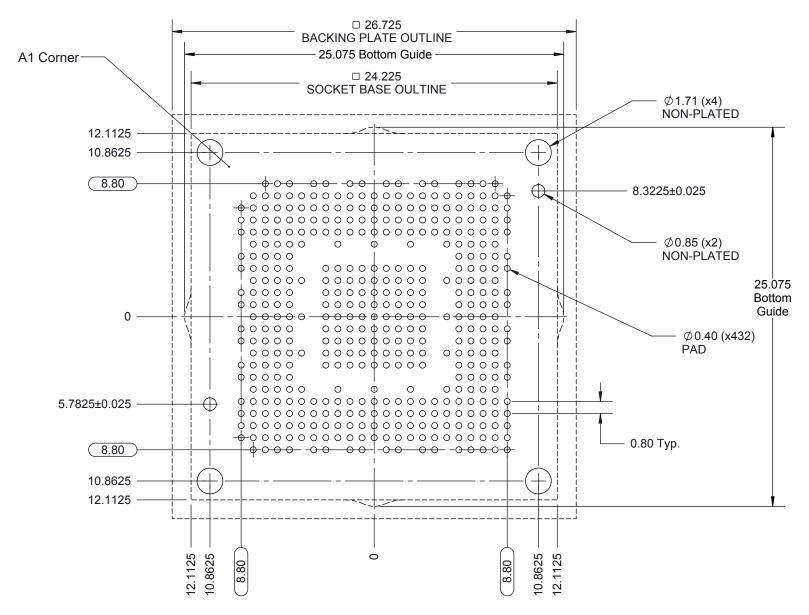
Tolerances: Hole diameters ±0.0254mm [±0.001"], Pitches (from true position) ±0.0762mm [±0.003"], substrate thickness tolerance ±10%, all other tolerances ±0.127mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.



Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodélectronics.com Material: Material <not specified> Finish:

STATUS: Released	SHEET: 1 OF 5	REV. C
ENG: V. Panavala	DRAWN BY: V. Panavala	SCALE: 1:1
FILE: CBT-BGA-6012	DATE: 9/6/2012	





**Target PCB Recommendations** 

Total thickness: 1.6mm min. Plating: Gold or Solder finish

PCB Pad height: same or higher than solder mask

## Description: Recommended PCB Layout

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

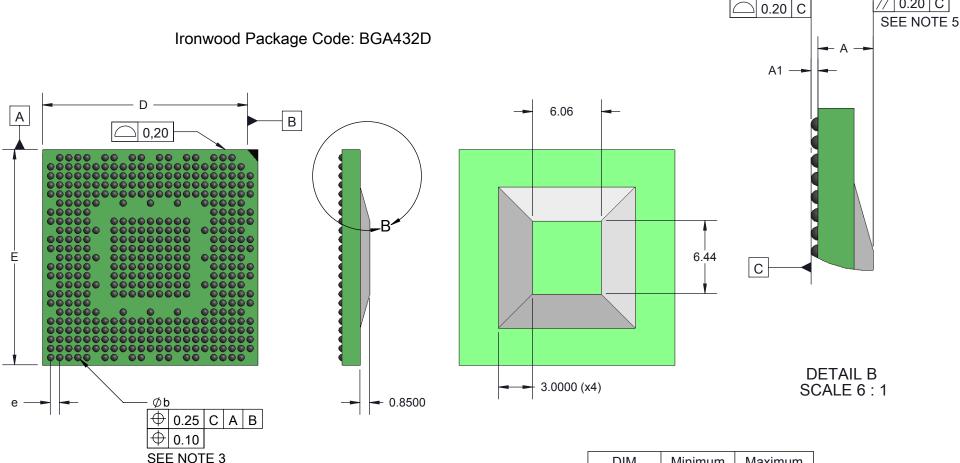
Tolerances: Hole diameters ±0.0254mm [±0.001"], Pitches (from true position) ±0.0762mm [±0.003"], substrate thickness tolerance ±10%, all other tolerances ±0.127mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

#### CBT-BGA-6012 Drawing



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STATUS: Released	SHEET: 2 OF 5	REV. C
ENG: V. Panavala	DRAWN BY: V. Panavala	SCALE: 4:1
FILE: CBT-BGA-6012	DATE: 9/6/2012	



- 1. Dimensions are in millimeters.
- Interpret dimensions and tolerances per ASME Y14.5M-1994.
   Dimension b is measured at the maximum solder ball diameter, parallel to datum plane C.
- Datum C (seating plane) is defined by the spherical crowns of the solder balls.
   Parallelism measurement shall exclude any effect of mark on top surface of package.

DIM	Minimum	Maximum	
Α		2.5	
A1	0.36	0.46	
b		0.60	
D	E 19.00 BSC e 0.8 BSC		
Е			
е			
ARRAY			
PIN COUNT	432		

# Description: Compatible BGA

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.0254mm [±0.001"], Pitches (from true position) ±0.0762mm [±0.003"], substrate thickness tolerance ±10%, all other tolerances ±0.127mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

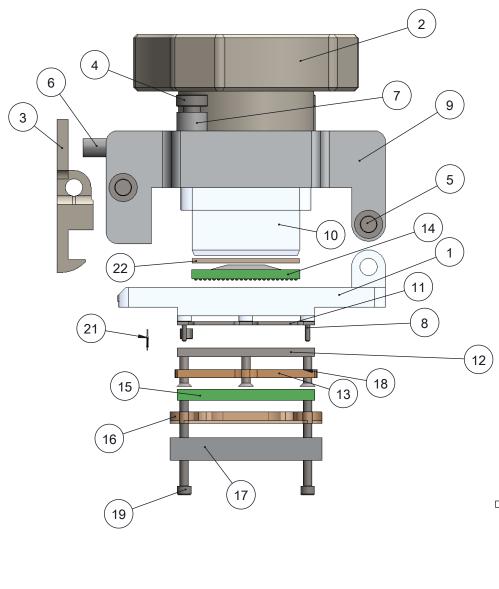
CBT-BGA-6012 Di	rawing
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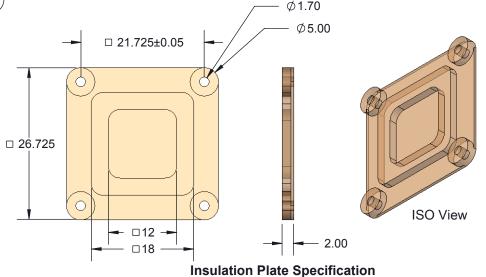
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Material: Material <not specified> Finish:

STATUS: Released	SHEET: 3 OF 5	REV. C
ENG: V. Panavala	DRAWN BY: V. Panavala	SCALE: 3:1
FILE: CBT-BGA-6012	DATE: 9/6/2012	



ITEM NO.	DESCRIPTION	Material	
1	CBT Socket Base 19mm centered pocket Ni Plated	7075-T6 Aluminum Alloy	
2	Compression Screw	7075-T6 Aluminum Alloy	
3	Latch	7075-T6 Aluminum Alloy	
4	Screw, M3 x 12mm, Low Head Cap, SS	18-8 Stainless Steel	
5	Hinge Pin and Snap Ring, 3mm OD, 30mm long, 1045 Stl, Blk Oxide	AISI 1045 Steel, cold drawn	
6	Precision Compression Spring, Zinc-Plated Music Wire, 1/2" Length, .12" OD, .016" Wire	Zinc Plated Music Wire	
7	Spring Clamshell lid assembly	Steel Music Wire	
8	Dowel pin, 1/32" X 1/4", SS	Stainless Steel (18-8)	
9	CBT socket lid for 19mm chip Ni Plated	7075-T6 Aluminum Alloy	
10	Compression plate 19mm	7075-T6 Aluminum Alloy	
11	Floating Guide 19mm 0.8mm 23X23 array centered	PEEK Ceramic filled	
12	Middle Guide 19mm 0.8mm 23X23 array centered	PEEK Ceramic filled	
13	Bottom Guide 19MM, 23X23 ARY, 0.8MM	Semitron MDS 100	
14	BGA Chip, 19MM 23X23ARRAY 0.8MM PITCH	Material <not specified=""></not>	
15	PCB, 19MM 23x23 ARRAY 0.8MM PITCH	Material <not specified=""></not>	
16	Insulation plate	Ultem	
17	Backing Plate 19mm	7075-T6, Plate (SS)	
18	#0-80X0.25", 90 deg., head pin guide screw, Peek material	PEEK unfilled	
19	#0-80 X .625 LG, SOC HD CAP SCREW, ALLOY STL, BLK OXIDE	Alloy Steel	
20	Floating Guide Spring	Alloy Steel (SS)	
21	SBT Pin, SBT-BGA 0.5mm-0.8mm		
22	IC frame 19mm IC 12.4mm pocket	Ultem/Cirlex	



# Description: Socket Assy, Insulation Plate

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

<u>Tolerances:</u> Hole diameters ±0.0254mm [±0.001"], Pitches (from true position) ±0.0762mm [±0.003"], substrate thickness tolerance ±10%, all other tolerances ±0.127mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

### **CBT-BGA-6012 Drawing**

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STATUS: Released	SHEET: 4 OF 5	REV. C
ENG: V. Panavala	DRAWN BY: V. Panavala	SCALE: 2:1
FILE: CBT-BGA-6012	DATE: 9/6/2012	

Rev	Date	Initials	Description
A 09/06/12 VP Original		Original	
В	B 02/18/14 DH Changed current rating of pin		Changed current rating of pin
С	C 4/3/15 RP/MR		P-P196A was P-P149A, R3182 was R1392

# **Description: Revision History**

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

CBT-BGA-6	6012 Drawing	Material: Finish: Weight:	STATUS: Released	SHEET: 5 OF 5	REV. C
	Tele: (800) 404-0204		ENG: V. Panavala	DRAWN BY: V. Panavala	SCALE: 2:1
		worght.	FILE: CBT-BGA-6012	DATE: 9/6/2012	